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APPLICATION NO.	FI	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/724,133	10/724,133 12/01/2003		Joon Hyeon Lee	P69337US0	1214
136	7590	12/27/2005	EXAMINER		
JACOBSON 400 SEVENT			DEO, DUY VU NGUYEN		
SUITE 600	II DIKE	LI IV. W.	ART UNIT	PAPER NUMBER	
WASHINGTO	ON, DC	20004	1765		

DATE MAILED: 12/27/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

		Appli	ication No.	Applicant(s)	Y		
Office Action Summary			24,133	LEE, JOON HYE	EON		
			niner	Art Unit			
		DuyV	'u n. Deo	1765			
Period fo	The MAILING DATE of this commu or Reply	nication appears o	n the cover sheet	with the correspondence a	ddress		
A SH WHIC - Exte after - If NC - Failu Any	ORTENED STATUTORY PERIOD IN CHEVER IS LONGER, FROM THE IN Insions of time may be available under the provision SIX (6) MONTHS from the mailing date of this come to period for reply is specified above, the maximum sure to reply within the set or extended period for reply received by the Office later than three months ed patent term adjustment. See 37 CFR 1.704(b).	MAILING DATE O is of 37 CFR 1.136(a). In imunication. statutory period will apply by will, by statute, cause the	F THIS COMMUI no event, however, may and will expire SIX (6) M ne application to become	NICATION. a reply be timely filed ONTHS from the mailing date of this abandoned (35 U.S.C. § 133).			
Status							
1)[\]	Responsive to communication(s) fil	ed on 18 October	2005				
	This action is FINAL .	2b) This action					
3)	Since this application is in condition	•		atters, prosecution as to th	ie merits is		
,—	closed in accordance with the pract		•	·			
Disposit	ion of Claims						
4)🖂	Claim(s) 1-11 is/are pending in the	application.					
	4a) Of the above claim(s) is/s	• •	n consideration.				
	Claim(s) is/are allowed.						
6)⊠	Claim(s) 1-11 is/are rejected.						
7)	Claim(s) is/are objected to.			·			
8)□	Claim(s) are subject to restri	ction and/or electi	ion requirement.				
Applicat	ion Papers						
9)[The specification is objected to by the	ne Examiner.					
10)🖂	The drawing(s) filed on 18 October	<u>2005</u> is/are: a)⊠	accepted or b)	objected to by the Examin	ner.		
	Applicant may not request that any obje	ection to the drawing	g(s) be held in abey	vance. See 37 CFR 1.85(a).			
	Replacement drawing sheet(s) including	g the correction is re	equired if the drawi	ng(s) is objected to. See 37 C	FR 1.121(d).		
11)	The oath or declaration is objected to	to by the Examine	r. Note the attach	ed Office Action or form P	TO-152.		
Priority ι	ınder 35 U.S.C. § 119						
	Acknowledgment is made of a claim ☐ All b)☐ Some * c)☐ None of:	for foreign priorit	y under 35 U.S.C	. § 119(a)-(d) or (f).			
	1. Certified copies of the priority documents have been received.						
	2. Certified copies of the priority						
	3. Copies of the certified copies	• •		en received in this Nationa	l Stage		
	application from the Internation	•	` ' '				
* 8	See the attached detailed Office action	on for a list of the	certified copies n	ot received.			
Attachmen	t(s)						
1) Notic	e of References Cited (PTO-892)		4) 🔲 Interview	w Summary (PTO-413)			
	e of Draftsperson's Patent Drawing Review (o(s)/Mail Date Informal Patent Application (PT)	·∩-152\		
	mation Disclosure Statement(s) (PTO-1449 o r No(s)/Mail Date	r PTO/SB/08)	6) Other: _		O-102)		

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1, 4, 5 are rejected under 35 U.S.C. 102(b) as being anticipated by Liu et al. (US 6,117,345).

Liu teaches a method for forming wiring lines comprising: depositing a metal layer 24 on a semiconductor structure (col., line 50-64); forming an insulating layer 28 and a photoresist on the metal layer (col. 4, line 30-40); patterning the insulating layer 28 using the pattern photoresist pattern to form an etching mask (col. 7, line 37-42); etching the metal line by using the photoresist and the insulating layer as a mask with gas mixture comprises Cl2 and BCl2, which would produce metal polymer on the pattern insulating film (col. 7, line 37-55); removing the photoresist and isotropically etching the insulating, this would also remove any metal polymer that forms on the insulating layer (col. 8, line 55; col. 9, line 25-32, 40-44).

Referring to claims 4 and 5, the insulating layer includes nitride and oxide (claimed top layer in the semiconductor structure).

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person

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having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

4. Claims 2, 3, 6, 7, 11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Liu as applied to claim 1 above, and further in view of Gutsche et al. (US 6,117,353).

Referring to claims 2 and 3, Liu doesn't describe the metal layer includes TiN below and above the Al, and a BARC between the photoresist and the insulating layer. This structure is typical and known to one skilled in the art as shown here by Gutsche (col. 1, line 25-45; col. 5, line 33-50). It would have been obvious for one skilled in the art to modify Liu in light of Gutsche's teaching in order to form a structure for forming a metal lines as taught by Gutsche (col. 1, line 5-19) with a reasonable expectation of success.

Referring to claim 7, Gutsche further teaches etching through the hard mask, which would include etching the BARC and the insulating layer, using a mixture of CF4, CHF3, and Ar.

Referring to claim 11, Gutsche further teaches of cleaning the substrate after the etching process (col. 6, line 40-45).

5. Claim 8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Liu and Gutsche as applied to claim 6 above, and further in view of Fujiwara et al. (US 6,232,209).

Referring to claim 8, above applied prior art doesn't describe etching the BARC and the insulating layer in a single etch step using gas mixture including CxFy, O2, and Ar. Fujiwara teaches an etching mixture for antireflective layer and the insulating layer including CF4, O2, and Ar (col. 11, line 41-55). It would have been obvious for one skilled in the art to etch the two layer in light of Fujiwara because he teaches another mixture that is known to one skilled in the

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art at the time of the invention to etch the two layer where the photoresist can be removed at the same time (col. 11, line 55-65) with a reasonable expectation of success.

6. Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over Liu, Gutsche, and Fujiwara as applied to claim 6 above, and further in view of Keil et al. (US 2002/0173160).

Referring to claim 9, Fujiwara further etching the antireflective and the insulating layer separately (col. 14, line 55-65). Unlike claimed invention, Fujiwara doesn't describe etching the antireflective using gas including N2. Keil teaches a mixture for etching antireflective including O2, N2, and Ar (claim 1; paragraph [0006]). It would have been obvious for one skilled in the art to etch the antireflective in light of Keil, when etching separately, since Keil teaches that the gas mixture would etch the antireflective layer selectively to the photoresist and the insulating layer (paragraph [0006]).

7. Claim 10 is rejected under 35 U.S.C. 103(a) as being unpatentable over Liu as applied to claim 1 above, and further in view of Lin et al. (US 6,063,695).

Referring to claim 10, Liu is silent about the gas mixture for isotropic etching of the insulating layer; however, isotropic etching using O2/CF4 for the insulating layer is well known to one skilled in the art as shown here by Lin (col. 5, line 35-45) (claimed down flow method). It would have been obvious for one skilled in the art to isotropically etch the insulating layer in light of Lin's teaching because Lin further describes the method and gas that is silent by Liu for the etching of the of the insulating layer with a reasonable expectation of success.

Response to Arguments

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8. Referring to applicant's argument that Liu fail to disclose a metal polymer as cited in claim 1, Liu describes using gas mixture of C2/BCl2 to etch the metal line. Since they are similar to the claimed etching gas disclosed in page 6, line 21 of the specification, Liu's metal line etching would provide metal polymer on the insulating pattern 28. Furthermore, Liu describes isotropically etching the insulating pattern 28 (please see col. 9, line 25-32, 40-44), which is also cited in claim 1, any metal polymer on the insulating pattern 28 would also have to be removed along with the insulating film.

Conclusion

9. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to DuyVu n. Deo whose telephone number is 571-272-1462. The examiner can normally be reached on 6:00-2:30 Mon-Fri.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine Norton can be reached on 571-272-1465. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Primary Examiner Duy-Vu N. Deo 12/21/05

KD